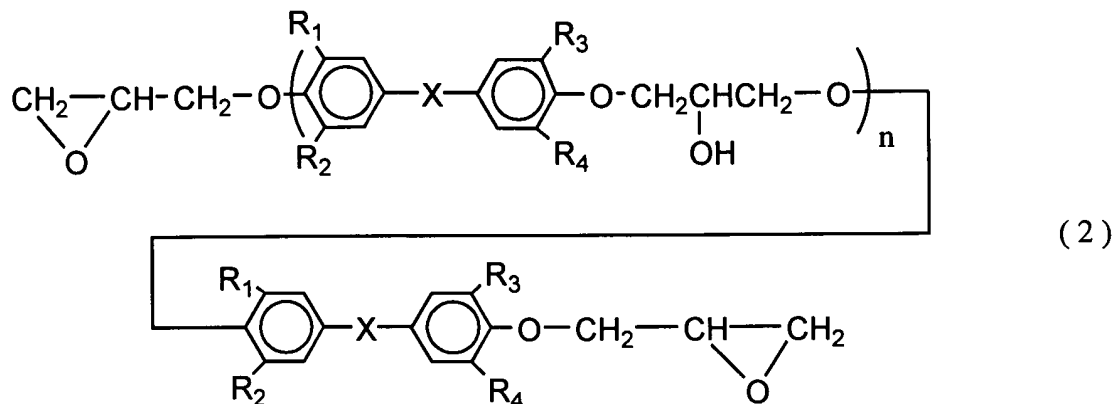


In the Specification:

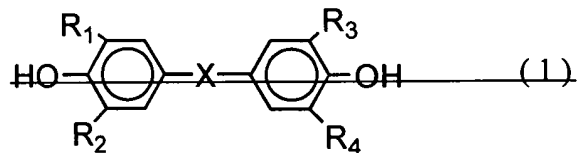
Please amend the specification as follows:

The paragraph at page 3, line 18 to page 4, line 11:

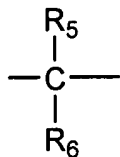
"That is the scope of the present invention is the epoxy resin represented by general formula (2),



wherein,  $R_1$ - $R_4$  indicate a hydrocarbon group of carbon number 1-6,  
 $n$  is 0 or integer of 1 or more and  $X$  ~~in aromatic compound (1)~~

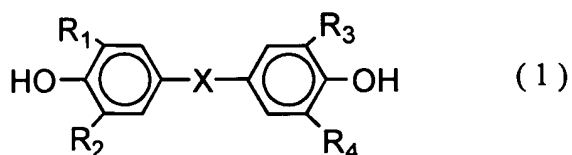


is a bond or the following general formula



wherein  ~~$R_1$ - $R_6$  indicates~~  $R_5$ - $R_6$  indicate a hydrogen atom or  
hydrocarbon group of carbon number 1-6,

obtained by reacting an aromatic compound represented by general  
formula (1) and epihalohydrine,



wherein R<sub>1</sub>-R<sub>4</sub> and X are as identified herein,

having molecular weight distribution comprising, content of n=0 component in the epoxy resin represented by general formula (2) is 60% or less and epoxy equivalent is 250g/eq or over, further the present invention is the cured product obtained by curing said epoxy resin, and is the coated product on which said epoxy resin composition is coated and cured."

The paragraph at page 4, line 14 to page 5, line 2:

"As the example of the aromatic compound represented by general formula (1),

3,3',5,5'-tetramethyl-4,4'-dihydroxydiphenylmethane,

~~4,4'-[(1,4-phenylene)bis(isopropylidene)]bis(2-methylphenol),~~

~~4,4'-[(1,4-phenylene)bis(isopropylidene)]bisphenol~~ and

4,4'-bishydroxy-3,3',5,5'-tetramethylbiphenyl can be mentioned, therefore, diglycidylether compound having epoxy resin structure represented by general formula (2) can be mentioned. Especially, diglycidylether compound of 3,3',5,5'-tetramethyl-4,4'-dihydroxydiphenylmethane is desirable. As the typical method for preparation of this compound, the method to react 3,3',5,5'-tetramethyl-4,4'-dihydroxydiphenylmethane (hereinafter shortened to tetramethylbisphenol F), which is the phenol compound obtained

by condensation reaction of 2,6xylenol and formaldehyde, with epihalohydrin can be mentioned. This reaction can be carried out same as to the conventional epoxidation reaction, namely, by a direct method for synthesis characterized by dissolving tetramethylbisphenol F in epihalohydrin and after that reacting these two compounds under the presence of alkali metal hydroxide catalyst such as sodium hydroxide or by an indirect method for synthesis characterized by reacting tetramethylbisphenol F with epoxy resin obtained by this method. In both methods, the reaction solvent can be used if necessary."

Table 1 at page 16:

Table 1

		Exam- ple 7	Exam- ple 8	Exam- ple 9	Co. Exp.2	Co. Exp.3
Resin	resin of Example 2	100	100			
	resin of Example 4			100		
	resin of Reference Example 2 1					100
	YD-014				100	
curing agent	dicyandiamide	3			3	
	CUREZOL 2PZ		3	3		3
accelerator	CUREZOL C11Z	0.5			0.5	
filler	titanium dioxide	5	5	5	5	5
	silica	30	30	30	30	30
	Acronal 4F	1	1	1	1	1
evaluation of coated film	appearance	○	○	○	○	○
	flexibility	○	○	○	○	×
	shock resistance	○	○	○	○	○
	boiling water resistance	○	○	○	△	○
generation of crystallinity of epoxy resin material		no	no	no	no	yes

Co. Exp.: Comparative Example